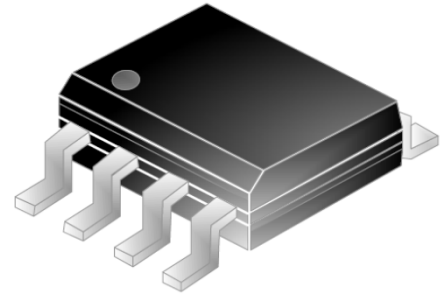


»Features

- Dual programmable transient suppressor.
- Wide negative firing voltage range:
 $V_{GKRM} = -167V$ max.
- Low dynamic switching voltage:
 V_{FRM} and $V_{GK(BD)}$
- Low gate triggering current:
 $I_{GT} = 5mA$ max
- Peak pulse current:
 $I_{PP} = 30A$ for 10/1000us surge
- Holding current:
 $I_H = 150mA$ min.
- Complies with The Following Standards:
YD/T 950-1998
ITU-T K.20
FCC part 68
GR-1089-CORE



SOP-8 (SO-8)

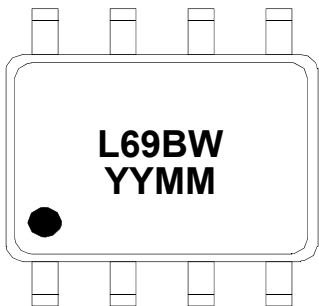
»Mechanical Characteristics

- SOP-8(SO-8) package
- Molding compound flammability rating: UL 94V-0
- Packaging: Tape and Reel
- RoHS/WEEE Compliant

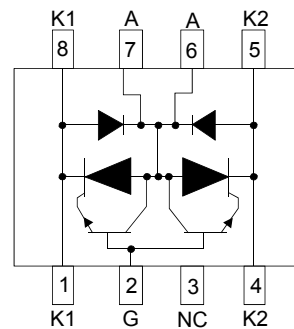
»Applications

- SLIC
- VoIP

»Marking Information



»Pin Configuration



»Summary of Packing Options

Package	Packing Description	Packing Quantity	Industry Standard
SOP-8	Tape/Reel, 13" reel	2500	EIA-481-1

»Absolute ratings ($T_A = 25\text{ }^\circ\text{C}$, unless otherwise specified)

Voltage waveform (μs)	Current waveform (μs)	Required peak current (A)
2/10 μs	2/10 μs	120
10/700 μs	5/310 μs	40
10/1000 μs	10/1000 μs	30

'1089 TEST CLAUSE AND TEST #	60 Hz power fault time	Required peak current (A)
4.5.13 Second-Level 2	500ms	6.5
4.5.13 Second-Level 2	1s	4.6
4.5.13 Second-Level 2	5s	2.3
4.5.13 Second-Level 1	30s	1.3
4.5.13 Second-Level 1	900s	0.73

Symbol	Parameter	Value	Unit
I_{PP}	Non-repetitive peak on-state pulse current		
	10/1000 μs	30	A
	5/310 μs	40	
	1.2/50 μs	100	
2/10 μs	120		
V_{PP}	10/700 μs	1600	V
I_{TSM}	Non repetitive surge peak on-state current (sinusoidal) 60Hz		A
	0.5s	6.5	
	1s	4.5	
	5s	2.3	
	30s	1.3	
900s	0.72		
V_{DRM}	Maximum voltage LINE/GROUND	-170	V
V_{GKRM}	Maximum voltage GATE/LINE	-167	
T_A	Operating free-air temperature range	-40~85	°C
T_{STG}	Storage temperature range	-40~150	
T_J	Junction temperature	-40~150	
T_L	Maximum lead temperature for soldering during 10S	260	
$R_{\theta JA}$	Junction to ambient	120	°C/W

»Electrical Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter
I_D	Off-state current
I_H	Holding current
$V_{(BO)}$	Breakover voltage
V_F	Forward voltage
V_{FRM}	Peak forward recovery voltage
$V_{GK(BO)}$	Gate-cathode impulse breakover voltage
I_{GKS}	Gate reverse current
I_{GT}	Gate trigger current
V_{GT}	Gate-cathode trigger voltage
C_{KA}	Cathode-anode off-state capacitance

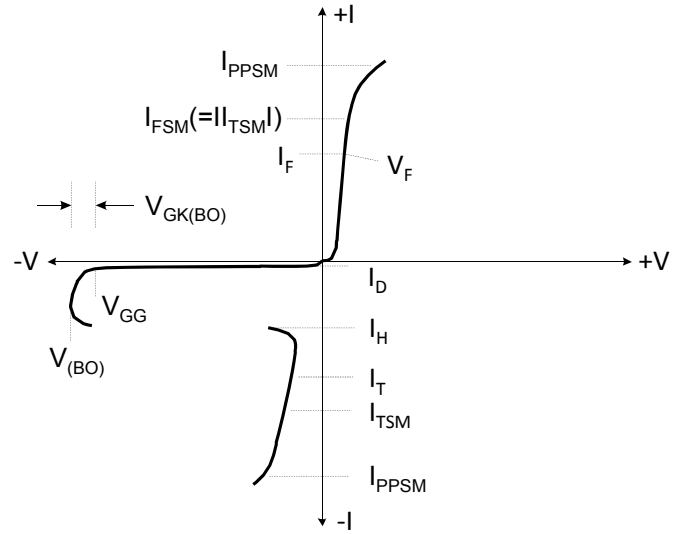


Figure 1. Voltage-Current Characteristic
Unless Otherwise Noted, All Voltages are Referenced to the Anode

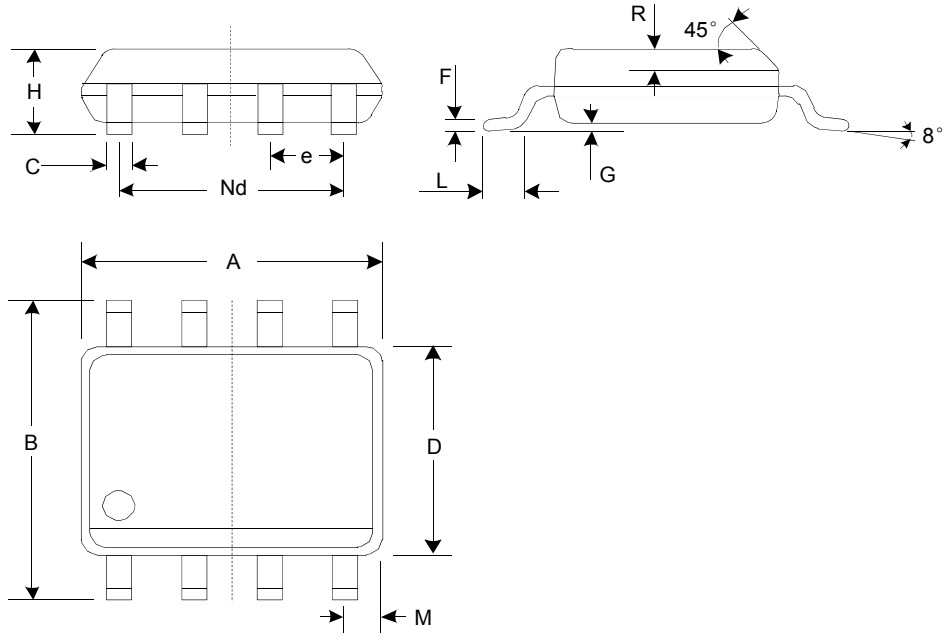
»Parameters Related to The Diode ($T_A=25^\circ\text{C}$)

Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_F forward voltage	$I_F=5A, t_w=200\mu s$			3	V
V_{FRM} peak forward recovery voltage	$2/10\mu s, I_F=100A, R_s=50\Omega, V_{GG}=-100V, C_G=220nF$			10	V

»Parameters Related to The Protection Thyristor ($T_A=25^\circ\text{C}$)

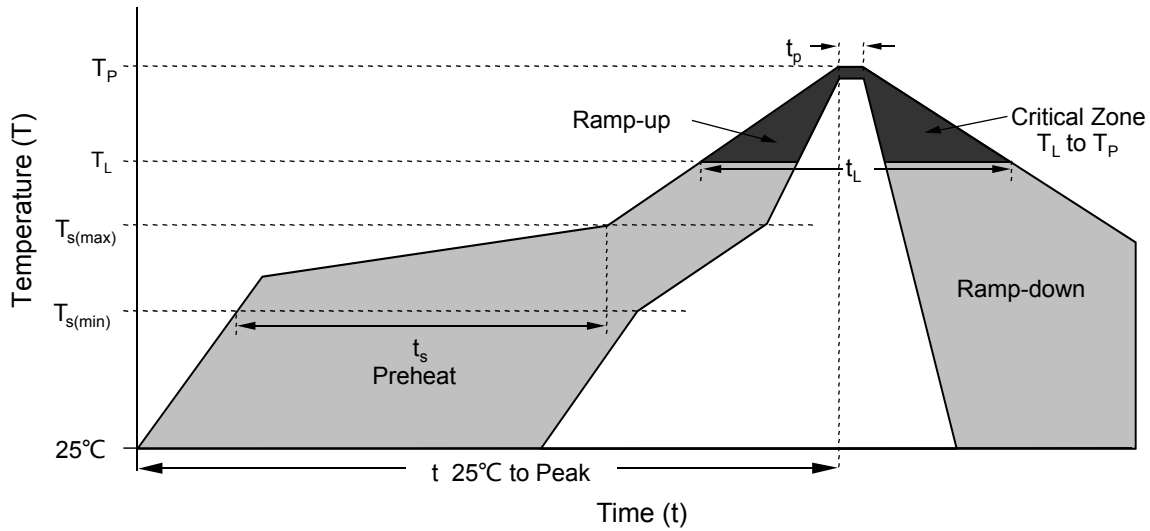
Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_D off-state current	$V_D=-170V, V_{GK}=0$	$T_J=25^\circ\text{C}$		-5	μA
		$T_J=85^\circ\text{C}$		-50	μA
V_{BO} breakover voltage	$2/10\mu s, I_T=-100A, R_s=50\Omega, V_{GG}=-100V, C_G=220nF$			-112	V
I_H holding current	$I_T=-1A, di/dt=1A/ms, V_{GG}=-100V$	-150			mA
I_{GKS} gate reverse current	$V_{GG}=V_{GK}=-100V, V_{KA}=0$	$T_J=25^\circ\text{C}$		-5	μA
		$T_J=85^\circ\text{C}$		-50	μA
I_{GT} gate trigger current	$I_T=3A, tp(g)\geq 20\mu s, V_{GG}=-100V$			5	mA
V_{GT} gate trigger voltage	$I_T=3A, tp(g)\geq 20\mu s, V_{GG}=-100V$			2.5	V
Q_{GS} gate switching charge	$1.2/50\mu s, I_T=-53A, R_s=47\Omega, V_{GG}=-100V, C_G=220nF$		0.1		μC
C_{KA} cathode-anode off-state capacitance	$f=1MHz, V_d=1V, I_G=0$	$V_D=-3V$		100	pF
		$V_D=-48V$		50	pF

»Package Dimensions



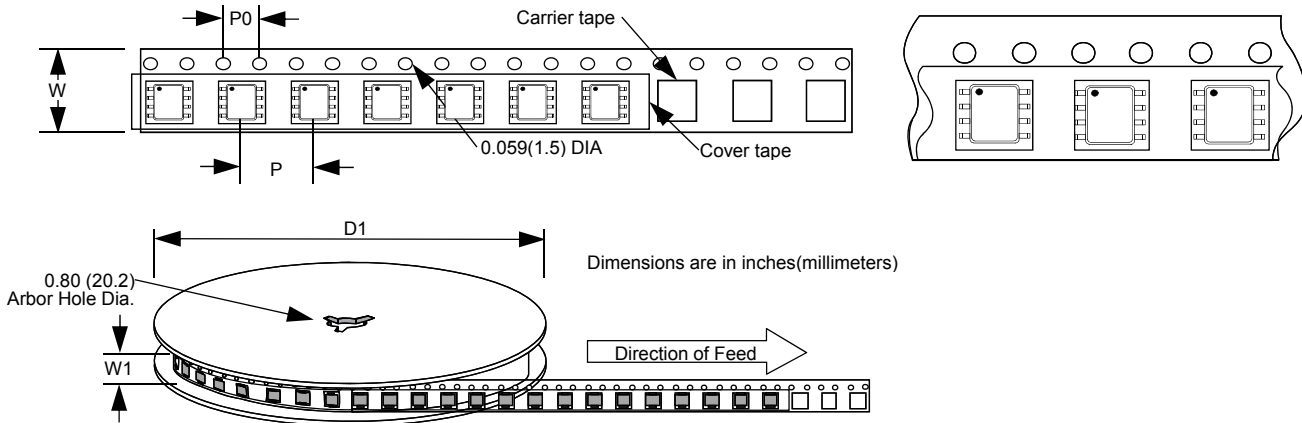
SOP-8						
Dimension	Inches			Millimeters		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.189		0.197	4.8		5
B	0.228		0.244	5.8		6.2
C	0.014		0.019	0.35		0.48
D	0.15		0.157	3.8		4
F	0.007		0.01	0.19		0.25
G	0.004		0.01	0.1		0.25
H			0.069			1.75
L	0.019	0.033	0.05	0.48	0.85	1.27
M			0.024			0.6
R		0.02			0.5	
e		0.05			1.27	
Nd		0.15			3.81	

»Soldering Parameters



Reflow Condition		Lead-free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_L) to peak)		3°C/second max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/second max
Reflow	- Temperature (T_L) (Liquidus)	217°C
	- Time (t_L)	60 – 150 secs
Peak Temperature (T_P)		260 ^{+0/-5} °C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 secs
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (t)		8 minutes Max.
Do not exceed		260°C

»Tape and Reel Specification



Dimension	Inches			Millimeters		
	MIN	NOM	MAX	MIN	NOM	MAX
P		0.315			8	
P0		0.157			4	
W		0.472			12	
W1		0.492			12.5	
D2		13			330	